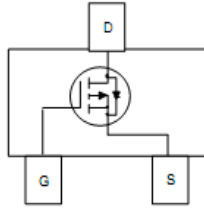
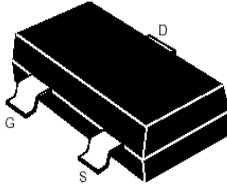


**SOT-23**


$V_{(BR)DSS}$	$R_{DS(ON)}$ Typ	$I_D$ Max
-60V	150m $\Omega$ @ 10V	-2A
	200m $\Omega$ @ 4.5V	

**Features**

- Low  $R_{DS(on)}$  @  $V_{GS} = -10V$
- -5V Logic Level Control
- P Channel SOT23 Package
- Pb-Free, RoHS Compliant

**Applications**

- Load Switch
- Switching Circuits
- High Speed line Driver

**Order Information**

Product	Package	Marking	Packing	Min Unit Quantity
SI2309	SOT23	N9A <u>X</u> X	3000PCS/Reel	3000PCS

**Absolute Maximum Ratings**

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter	Rating	Unit
<b>Common Ratings (<math>T_A = 25^\circ\text{C}</math> Unless Otherwise Noted)</b>			
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	-60	V
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-50 to 150	$^\circ\text{C}$
<b>Mounted on Large Heat Sink</b>			
$I_{DM}$	Pulse Drain Current Tested①	$T_A = 25^\circ\text{C}$	-8 A
$I_D$	Continuous Drain Current	$T_A = 25^\circ\text{C}$	-2 A
		$T_A = 70^\circ\text{C}$	-1.6 A
$P_D$	Maximum Power Dissipation	$T_A = 25^\circ\text{C}$	1 W
		$T_A = 70^\circ\text{C}$	0.8 W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	125	$^\circ\text{C/W}$

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-60	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current(T <sub>A</sub> =25°C)	V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V	--	--	-1	μA
	Zero Gate Voltage Drain Current(T <sub>A</sub> =125°C)	V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V	--	--	-100	uA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1.0	-1.5	-2.5	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance②	V <sub>GS</sub> =-10V, I <sub>D</sub> =-2A	--	150	200	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance②	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1A	--	200	300	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V, f=1MHz	--	310	--	pF
C <sub>oss</sub>	Output Capacitance		--	22	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	15	--	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =-30V I <sub>D</sub> =-2A, V <sub>GS</sub> =-10V	--	5.4	--	nC
Q <sub>gs</sub>	Gate Source Charge		--	1.1	--	nC
Q <sub>gd</sub>	Gate Drain Charge		--	1.6	--	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn on Delay Time	V <sub>DD</sub> =-30V, I <sub>D</sub> =-2A, R <sub>G</sub> =3.3Ω, V <sub>GS</sub> =-10V	--	41	--	ns
t <sub>r</sub>	Turn on Rise Time		--	22	--	ns
t <sub>d(off)</sub>	Turn Off Delay Time		-	25	--	ns
t <sub>f</sub>	Turn Off Fall Time		--	32	--	ns
<b>Source Drain Diode Characteristics</b>						
I <sub>SD</sub>	Source drain current(Body Diode)	T <sub>A</sub> =25°C	--	--	-1.4	A
V <sub>SD</sub>	Forward on voltage②	T <sub>J</sub> =25°C, I <sub>SD</sub> =-2A, V <sub>GS</sub> =0V	--	-0.84	-1.2	V

Notes:

① Pulse width limited by maximum allowable junction temperature

②Pulse test ; Pulse width≤300μs, duty cycle≤2%.

Typical Characteristics

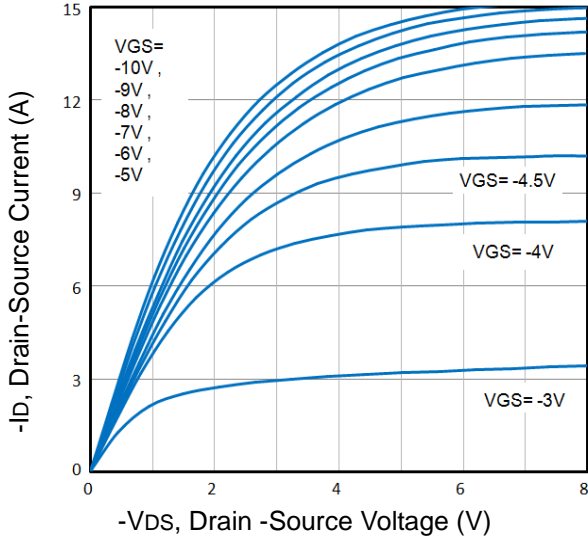


Fig1. Typical Output Characteristics

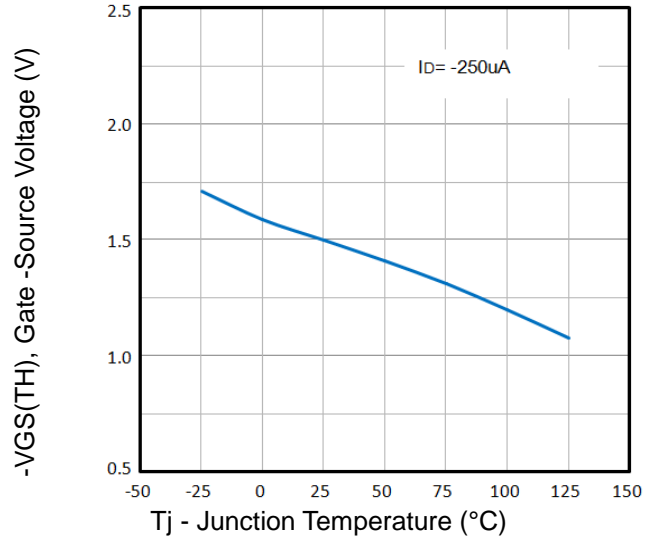


Fig2. Normalized Threshold Voltage Vs. Temperature

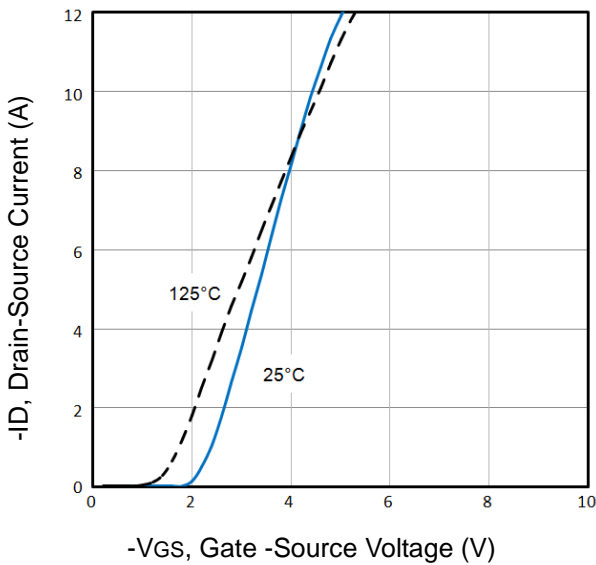


Fig3. Typical Transfer Characteristics

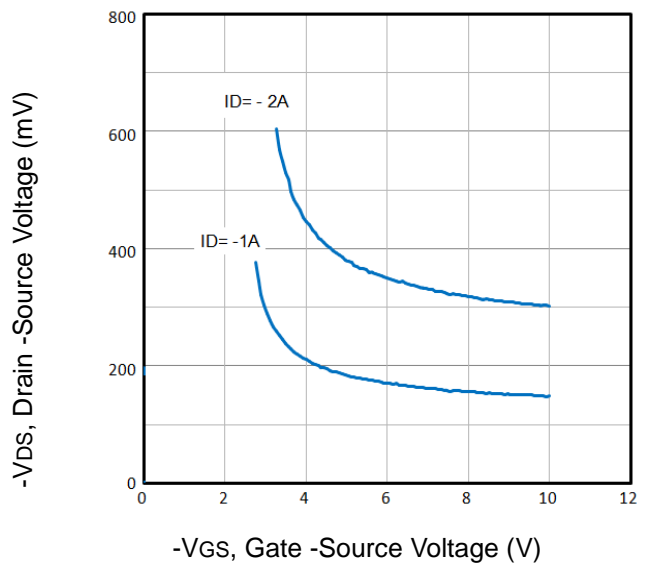


Fig4. Drain -Source Voltage vs Gate -Source Voltage

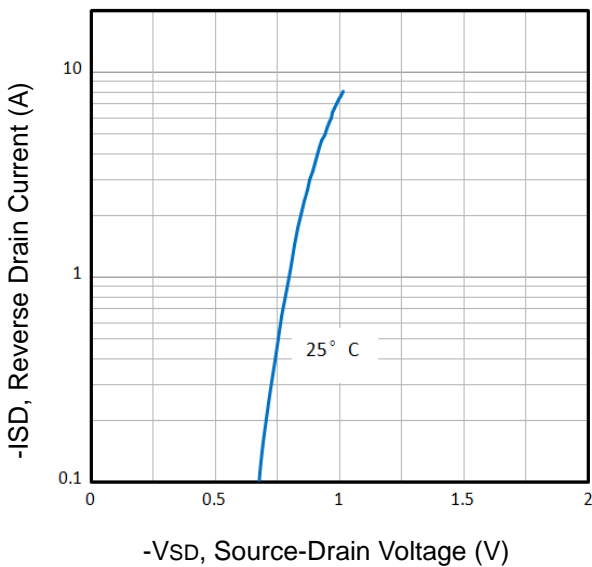


Fig5. Typical Source-Drain Diode Forward Voltage

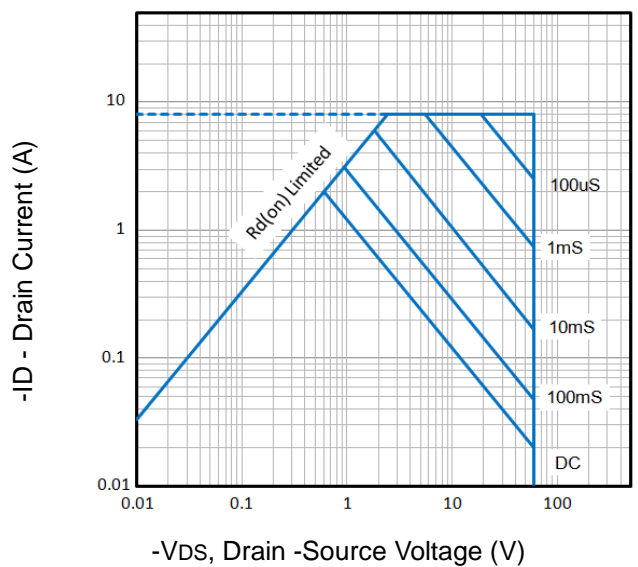


Fig6. Maximum Safe Operating Area

Typical Characteristics

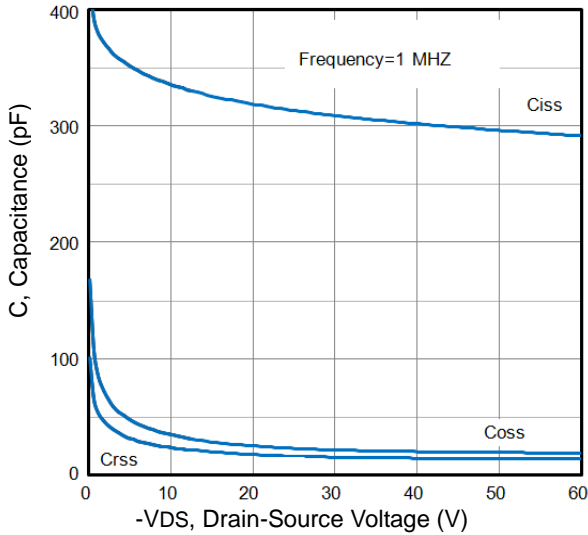


Fig7. Typical Capacitance Vs. Drain-Source Voltage

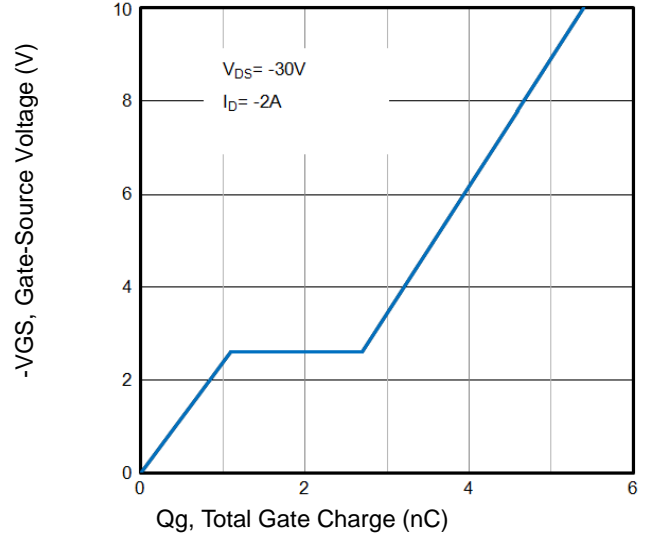


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

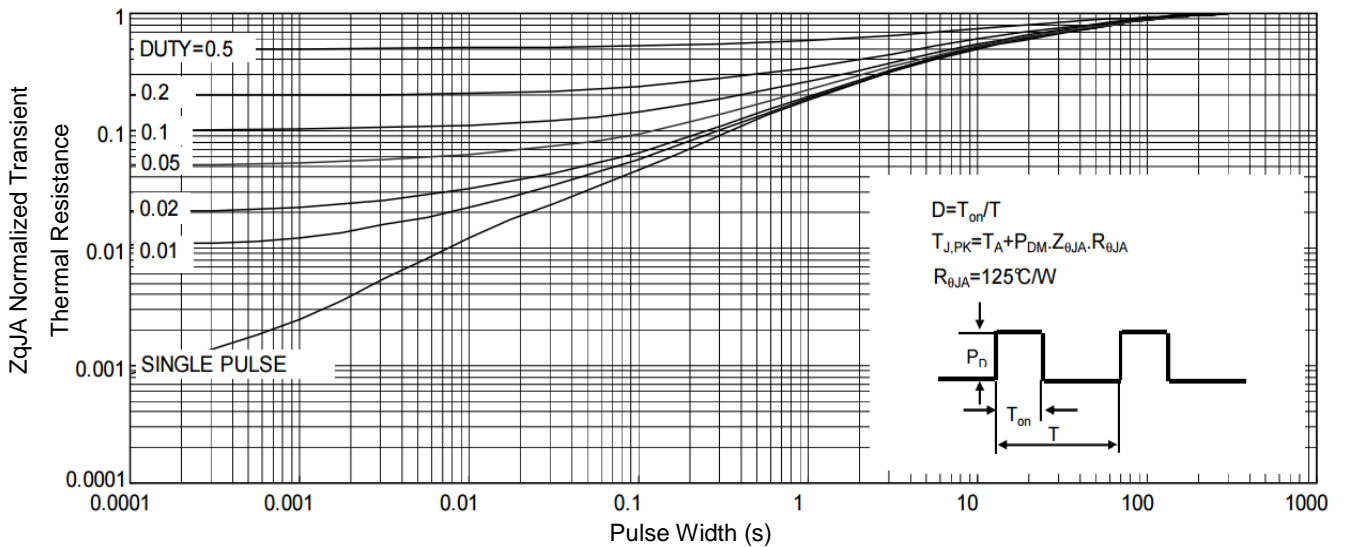
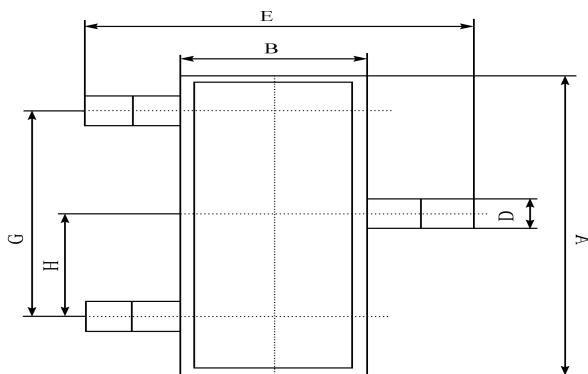


Fig9. Normalized Maximum Transient Thermal Impedance

SOT-23 PACKAGE OUTLINE Plastic surface mounted package



SOT-23	
A	2.90 ± 0.10
B	1.30 ± 0.10
C	1.00 ± 0.10
D	0.40 ± 0.10
E	2.40 ± 0.20
G	1.90 ± 0.10
H	0.95 ± 0.05
J	0.13 ± 0.05
K	0.00-0.10
M	≥ 0.2
N	0.60 ± 0.10
P	7 ± 2°

(UNIT): mm

